



# **SPECIFICATION**

(Reference sheet)

- Supplier : Samsung electro-mechanics - Samsung P/N : CL21C100JBANFNC

Product : Multi-layer Ceramic Capacitor
 Description : CAP, 10pF, 50V, ± 5%, C0G, 0805

### A. Samsung Part Number

<u>CL</u> <u>21</u> <u>C</u> <u>100</u> <u>J</u> <u>B</u> <u>A</u> <u>N</u> <u>F</u> <u>N</u> <u>C</u> ① ② ③ ④ ⑤ ⑥ ⑦ ⑧ ⑨ ⑩ ⑪

| 1 | Series        | Samsung Multi-layer Ceramic Capacitor |                   |                               |
|---|---------------|---------------------------------------|-------------------|-------------------------------|
| 2 | Size          | 0805 (inch code)                      | L: 2.00 ± 0.10 mm | W: 1.25 ± 0.10 mm             |
|   |               |                                       |                   |                               |
| 3 | Dielectric    | C0G                                   | 8 Inner electrode | Ni                            |
| 4 | Capacitance   | <b>10</b> pF                          | Termination       | Cu                            |
| ⑤ | Capacitance   | ± 5%                                  | Plating           | Sn 100% (Pb Free)             |
|   | tolerance     |                                       | Product           | Product for POWER application |
| 6 | Rated Voltage | 50 V                                  | Special           | Reserved for future use       |
| 7 | Thickness     | 0.65 ± 0.10 mm                        | Packaging         | Cardboard Type, 7" reel       |

#### B. Structure and dimension



| Samsung P/N     | Dimension(mm) |             |             |                 |  |
|-----------------|---------------|-------------|-------------|-----------------|--|
| (Lead Free)     | L             | W           | Т           | BW              |  |
| CL21C100JBANFNC | 2.00 ± 0.10   | 1.25 ± 0.10 | 0.65 ± 0.10 | 0.50+0.20/-0.30 |  |

#### C. Samsung Reliability Test and Judgement condition

|                                     |   | Test condition   |  |  |  |  |
|-------------------------------------|---|--|--|--|--|--|
| Capacitance                         | Within specified tolerance  | 1 <sup>MHz</sup> ±10% / 0.5~5Vrms                            |  |  |  |  |
| Q 600 min                           |   | 1  |  |  |  |  |
| Insulation 10,000Mohm or 500Mohm×μF |   | Rated Voltage 60~120 sec.                                    |  |  |  |  |
| Resistance                          | Whichever is smaller  |  |  |  |  |  |
| Appearance                          | No abnormal exterior appearance                                   | Microscop (X10)  |  |  |  |  |
| Withstanding                        | No dielectric breakdown or  | 300% of the rated voltage                                    |  |  |  |  |
| Voltage                             | mechanical breakdown  |  |  |  |  |  |
| Temperature C0G                     |   |  |  |  |  |  |
| Characteristics                     | (From -55℃ to 125℃, Capacitance change should be within ±30PPM/℃) |  |  |  |  |  |
| Adhesive Strength                   | No peeling shall be occur on the                                  | 500g×F, for 10±1 sec.  |  |  |  |  |
| of Termination                      | terminal electrode  |  |  |  |  |  |
| Bending Strength                    | Capacitance change :  | Bending to the limit (1mm)                                   |  |  |  |  |
| ,                                   | within ±5% or ±0.5pF whichever is larger                          | with 1.0mm/sec.  |  |  |  |  |
|                                     | More than 75% of terminal surface                                 | SnAg3.0Cu0.5 solder  |  |  |  |  |
| ļi li                               | is to be soldered newly   | 245±5℃, 3±0.3sec.  |  |  |  |  |
|                                     |   | (preheating : 80~120 ℃ for 10~30sec.)                        |  |  |  |  |
|                                     |   | ,  |  |  |  |  |
| Resistance to                       | Capacitance change :  | Solder pot : 270±5 °C, 10±1sec.                              |  |  |  |  |
| Soldering heat                      | within ±2.5% or ±0.25pF whichever is larger                       |  |  |  |  |  |
|                                     | Tan δ, IR : initial spec.   |  |  |  |  |  |
| Vibration Test                      | Capacitance change :  | Amplitude : 1.5mm  |  |  |  |  |
| l,                                  | within ±2.5% or ±0.25pF whichever is larger                       | From 10Hz to 55Hz (return : 1min.)                           |  |  |  |  |
|                                     | Tan δ, IR : initial spec.   | 2hours ´ 3 direction (x, y, z)                               |  |  |  |  |
| Moisture                            | Capacitance change :  | With rated voltage   |  |  |  |  |
| Resistance                          | within ±7.5% or ±0.75pF whichever is larger                       | 40±2℃, 90~95%RH, 500+12/-0hrs                                |  |  |  |  |
|                                     | Q: 133.33 min   |  |  |  |  |  |
| Į.                                  | IR: 500Mohm or 25Mohm × $\mu$ F                                   |  |  |  |  |  |
|                                     | Whichever is smaller  |  |  |  |  |  |
| High Temperature                    | Capacitance change :  | With 200% of the rated voltage                               |  |  |  |  |
|                                     | within ±3% or ±0.3pF whichever is larger                          | Max. operating temperature                                   |  |  |  |  |
|                                     | Q: 300 min  | 1000+48/-0hrs  |  |  |  |  |
| l l                                 | IR: 1,000Mohm or 50Mohm × $\mu$ F                                 |  |  |  |  |  |
|                                     | Whichever is smaller  |  |  |  |  |  |
| Temperature                         | Capacitance change :  | 1 cycle condition  |  |  |  |  |
| -                                   | within ±2.5% or ±0.25pF whichever is larger                       | Min. operating temperature → 25 °C                           |  |  |  |  |
|                                     | Tan δ, IR : initial spec.   | $\rightarrow$ Max. operating temperature $\rightarrow$ 25 °C |  |  |  |  |
|                                     | •   |  |  |  |  |  |
|                                     |   |  |  |  |  |  |
|                                     |   | 5 cycle test   |  |  |  |  |

<sup>\*</sup> The reliability test condition can be replaced by the corresponding accelerated test condition.

#### D. Recommended Soldering method:

Reflow ( Reflow Peak Temperature : 260+0/-5 °C, 10sec. Max )



A Product specifications included in the specifications are effective as of March 1, 2013.

Please be advised that they are standard product specifications for reference only.

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- ② Automotive or Transportation equipment (vehicles, trains, ships, etc)
- 3 Medical equipment
- Military equipment
- 5 Disaster prevention/crime prevention equipment
- Any other applications with the same as or similar complexity or reliability to the applications set forth above.